

# Technical Data Sheet

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Customer:	
<b>Customer PN:</b>	
Version No.:	A.4
Date:	June 16th, 2015
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Shenzhen RigDoo Optoelectronics Co., Ltd.

E-mail: info@rigdoo.com Http://www.RigDoo.com



#### RigDoo **Technical Sheet** Data

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#### 1. Features

Package (L/W/H):  $5.4 \times 5.0 \times 1.6$  mm

Color: Ultra Bright White Color

Lens: Water Clear Flat Mold

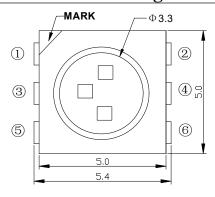
EIA STD Package

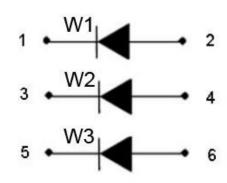
Meet ROHS, Green Product

Compatible With SMT Automatic Equipment

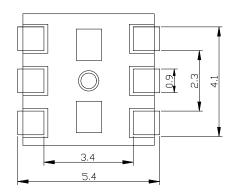
• Compatible With Infrared Reflow Solder Process

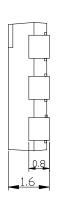
## 2. Package Profile & Soldering PAD Suggested





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Notes: a. All dimensions are in millimeters;

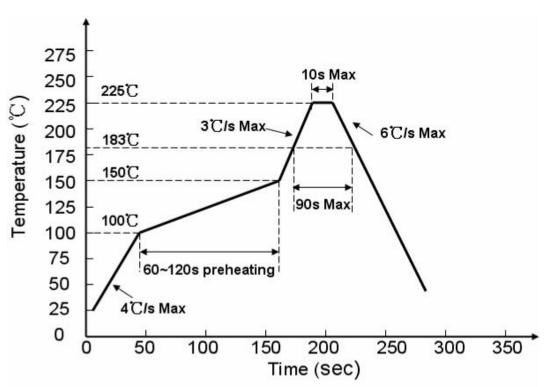
b. Tolerance is  $\pm$  0.10 mm unless otherwise noted.



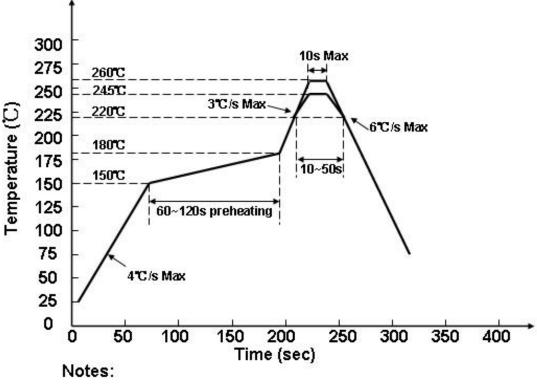
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## 3. Soldering Profile Suggested

For Lead Solder



For Lead Free Solder



We recommend the soldering temperature 245±5℃; The maximum temperature should be limited to 260 ℃.

# 4. Absolute Maximum Ratings At Ta=25°C



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Parameter	Symbol	R	ating	Unit	
		W1	110		
Power Dissipation	Pd	W2	110	mW	
		W3	110		
Peak Forward Current		W1	100		
(1/10 Duty Cycle, 0.1ms Pulse Width)	Ifp	W2	100	mA	
(1710 Duty Cycle, 0.11115 Fulse Width)		W3	100		
		W1	30		
DC Forward Current	IF	W2	30	mA	
		W3	30		
		W1	5		
Reverse Voltage	$V_R$	W2	5	$\mathbf{V}$	
		W3	5		
Operating Temperature Range	Topr		-30°C ∼	+ 85 ° C	
Storage Temperature Range	Tstg	-40°C ~ +90°C			
Soldering Condition	Tsol	Reflow soldering: 260°C For 5 Seconds Hand soldering: 300°C For 3 Seconds			



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	T	T	T	Γ	I	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Lumen	Φ	24	25	26	lm	IF = 60mA
Color Rendering Index	Ra		78			IF = 60mA
Viewing Angle	201/2		120		deg	IF = 60mA
CIE 1931 Coordinate	X/Y		X=0.32 Y=0.33			IF=60mA
Color Temperature	CCT	6000		6500	K	IF=60mA
Forward Voltage	VF	2.8		3.6	V	IF=60mA
Reverse Current	IR			5	uA	VR=5V

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta$ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

# 1) IV:

Bin	Min	Max	Unit	Condition



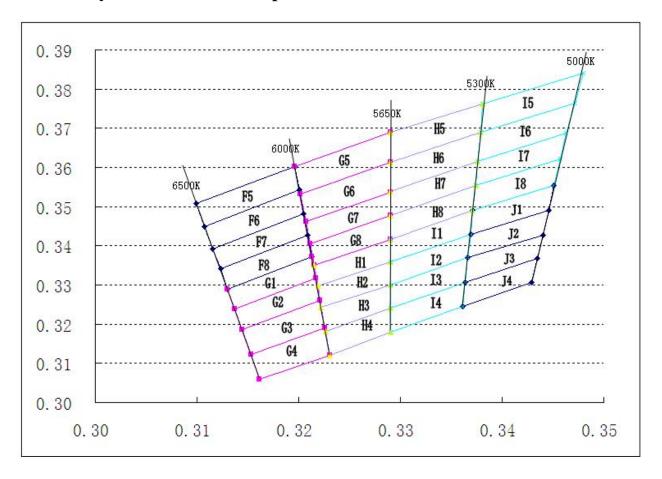
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W1	22	24		
W2	24	26	LM	IF=60mA

## 2) VF:

Bin	Min	Max	Unit	Condition
6	2.8	3.0		
7	3.0	3.2		
8	3.2	3.4	V	IF=60mA
9	3.4	3.6		

# **Chromaticity Coordinate Groups**





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Bin Cod	CIE-X	CIE-Y	Bin Cod	CIE-X	CIE-Y	Bin Cod	CIE-X	CIE-Y	Bin Cod	CIE-X	CIE-Y
	0. 337	0.349		0. 3130	0. 3290		0. 3215	0. 3350		0. 3290	0. 3417
	0.336	0.343		0. 3137	0. 3238		0. 3219	0. 3297		0. 3290	0. 3359
Ј1	0. 344	0. 349	G1	0. 3217	0. 3317	H1	0.3290	0. 3359	I1	0. 3369	0. 3430
	0.345	0. 355		0. 3213	0. 3373		0.3290	0.3417		0. 3371	0. 3490
	0.336	0. 343		0. 3137	0. 3238		0.3219	0. 3297		0. 3290	0. 3359
	0.336	0. 336		0. 3144	0. 3186		0.3222	0. 3243		0. 3290	0.3300
J2	0.344	0.342	G2	0. 3221	0. 3261	Н2	0. 3290	0.3300	12	0. 3366	0. 3369
	0.344	0.349		0. 3217	0. 3317		0.3290	0.3359		0. 3369	0. 3430
	0.336	0.336		0. 3144	0. 3186		0. 3222	0. 3243		0.3290	0.3300
	0.336	0.330		0. 3153	0. 3123		0. 3227	0.3182		0. 3290	0. 3240
Ј3	0.343	0.336	G3	0. 3226	0. 3191	Н3	0.3290	0. 3240	13	0. 3364	0. 3307
	0.344	0. 342		0. 3221	0. 3261		0.3290	0.3300		0. 3366	0. 3369
	0.336	0.330		0. 3153	0. 3123		0. 3227	0.3182		0.3290	0. 3240
	0.336	0.324		0. 3161	0. 3059		0.3231	0.3120		0. 3290	0.3180
J4	0. 342	0.330	G4	0. 3231	0. 3120	H4	0.3290	0.3180	I4	0. 3361	0. 3245
	0. 343	0.336		0. 3226	0. 3191		0.3290	0.3240		0.3364	0. 3307
	0.309	0.350		0. 3202	0. 3532		0.3290	0.3690		0. 3381	0. 3762
	0.310	0. 345		0. 3290	0. 3614		0.3290	0.3614		0. 3379	0. 3689
F5	0.320	0.354	G5	0. 3290	0. 3690	Н5	0. 3379	0.3689	I5	0. 3472	0. 3764
	0.319	0.360		0.3196	0.3602		0. 3381	0. 3762		0.3480	0. 3840
	0.309	0.350					0.3290	0.3690		0. 3381	0. 3762
	0.310	0. 345		0. 3202	0. 3532		0. 3290	0.3614		0.3379	0. 3689
	0.311	0.339		0. 3207	0. 3462		0.3290	0. 3538		0. 3376	0.3616
F6	0.320	0.348	G6	0. 3290	0. 3537	Н6	0. 3376	0.3616	16	0. 3463	0. 3687
	0.320	0.354		0. 3290	0. 3614		0. 3379	0. 3689		0. 3472	0.3764

Notes: Tolerance of the CIE X,Y: +/-0.005

# 6. Typical Electrical-Optical Characteristics Curves



#### **Technical** RigDoo **Sheet** Data

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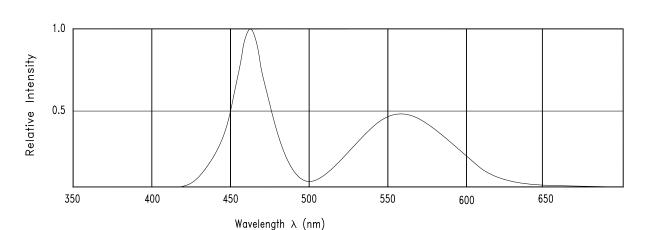
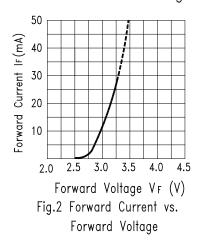
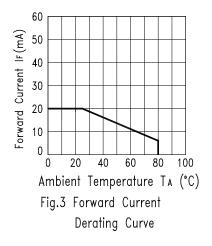


Fig.1 Relative Intensity vs. Wavelength





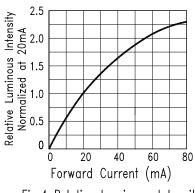


Fig.4 Relative Luminous Intensity vs. Forward Current

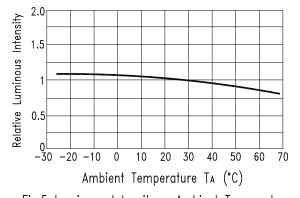


Fig.5 Luminous Intensity vs.Ambient Temperature

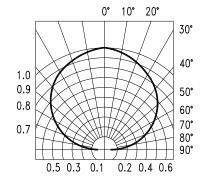


Fig.6 Spatial Distribution

# 7. Label explanation



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CAT: Luminous Intensity Rank (unit: mcd)
HUE: Dominant Wavelength Rank (unit: nm)

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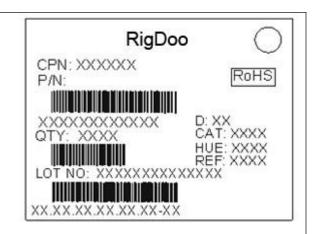
REF: Forward Voltage Rank (unit: V)

Rank Tolerance:

a. Luminous Intensity:  $\pm 11\%$ 

b.  $HUE: \pm 1nm$ 

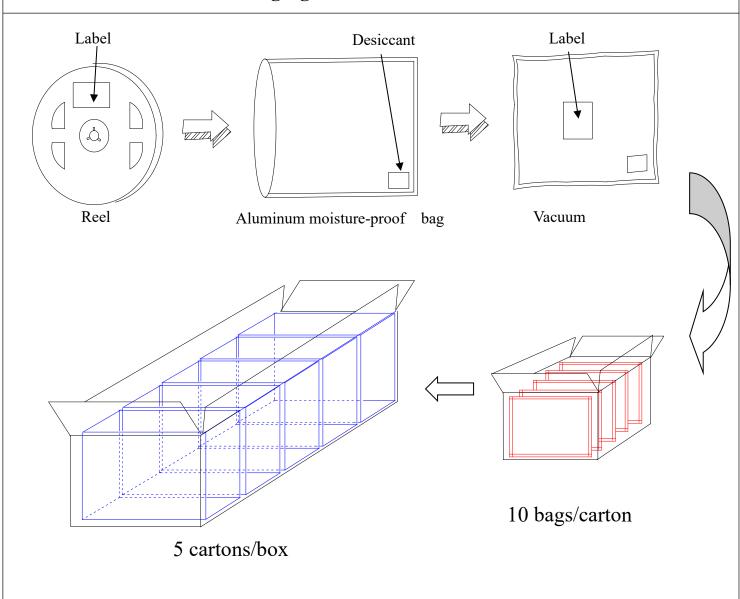
c. Forward Voltage:  $\pm 0.02V$ 



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# 8. Moisture Resistant Packaging:



# 9. Reliability Test



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Fait No <b>KD</b> 3030-1030 W 0 W 0 W D-ED193						
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Classification	Test Item	Test Condition	Reference Standard	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS,+72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5°C,RH= 85%	1000HRS±2HRS	JESD22-A101
Test	High Temperature Storage	Ta= 105±5°C	1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008  JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C	1000HRS (-24HRS,+72H RS)	ЛS C 7021:В-12
	Temperature Cycling	105°C ~ 25°C ~ -55°C ~ 25°C 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	$85 \pm 5^{\circ}\text{C} \sim -40^{\circ}\text{C} \pm 5^{\circ}\text{C}$		MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T.sol= $260 \pm 5$ °C	$10 \pm 1 \mathrm{secs}$	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
Environmental Test	IR-Reflow Normal Process	Ramp-up rate(183°C to Peak) +3°C/ second max  Temp. maintain at 125(±25)°C 120 seconds max  Temp. maintain above 183°C 60-150 seconds  Peak temperature range 235°C+5/-0°C  Time within 5°C of actual Peak Temperature (tp)  10-30 seconds  Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max  Temp. maintain at 175(±25)°C 180 seconds max  Temp. maintain above 217°C 60-150 seconds  Peak temperature range 260°C+0/-5°C  Time within 5°C of actual Peak Temperature (tp)  20-40 seconds  Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	Solderability	T.sol= $235 \pm 5$ °C Immersion rate $25\pm2.5$ mm/sec Coverage $\geq 95\%$ of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

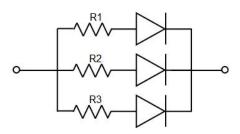
# 10. Cautions

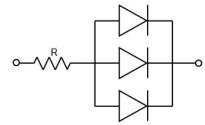


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#### Application

- 1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
- 2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.





Circuit model A

Circuit model B

3. High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

#### **Storage**

- 1.Before opening original package, it is recommended to store them in the following environment: Temperature: 5°C~30°C, Humidity: 85%RH max. When the inventory over 2 months, Should be done before treatment using dehumidification, Temperature: 60°C/8 hours.
- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 48hrs (2 days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 48hrs (2 days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

#### **ESD** (Electrostatic Discharge )-Protection

A LED (especially the Blue. White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc. Some advice as below should be noticed:

- 1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.
- 2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded (Grounding impedance value within  $10\Omega$ ) .



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- 3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
- 4. Use ionizer to neutralize the static charge during handling or operating.
- 5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

#### Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

#### **Soldering**

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 1.
- 2. Reflow soldering should not be done more than 2 times.
- 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

#### **Others**

- 1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult RigDoo's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
- 2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
- 3. The appearance and specifications of the product may be modified for improvement without prior notice.
- 4. LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating.